

# RQJ0306FQDQA

Silicon P Channel MOS FET  
Power Switching

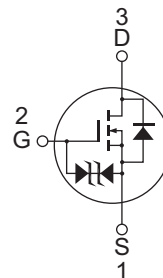
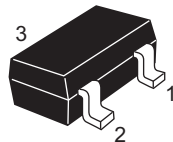
R07DS0298EJ0300  
Rev.3.00  
Jan 10, 2014

## Features

- Low gate drive  
     $V_{DSS}$  : -30 V and 2.5 V gate drive
- Low drive current
- High speed switching
- Small traditional package (MPAK)

## Outline

RENESAS Package code: PLSP0003ZB-A  
(Package name: MPAK)



1. Source
2. Gate
3. Drain

Notes: Marking is "FQ".

## Absolute Maximum Ratings

( $T_a = 25^\circ\text{C}$ )

| Item                                     | Symbol                          | Ratings     | Unit             |
|--|---------------------------------|-------------|------------------|
| Drain to source voltage                  | $V_{DSS}$                       | -30         | V                |
| Gate to source voltage                   | $V_{GSS}$                       | +8 / -12    | V                |
| Drain current                            | $I_D$                           | -3          | A                |
| Drain peak current                       | $I_{D(pulse)}$ <sup>Note1</sup> | -12         | A                |
| Body - drain diode reverse drain current | $I_{DR}$                        | 3           | A                |
| Channel dissipation                      | $P_{ch}$ <sup>Note2</sup>       | 0.8         | W                |
| Channel temperature                      | $T_{ch}$                        | 150         | $^\circ\text{C}$ |
| Storage temperature                      | $T_{stg}$                       | -55 to +150 | $^\circ\text{C}$ |

Notes: 1.  $PW \leq 10 \mu\text{s}$ , Duty cycle  $\leq 1\%$

2. When using the glass epoxy board (FR-4 40 × 40 × 1 mm)

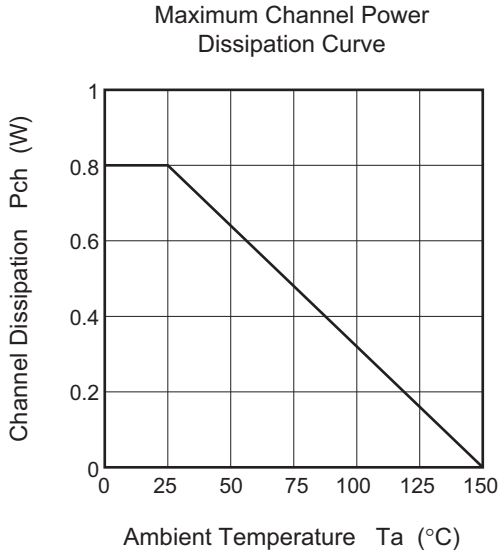
## Electrical Characteristics

(Ta = 25°C)

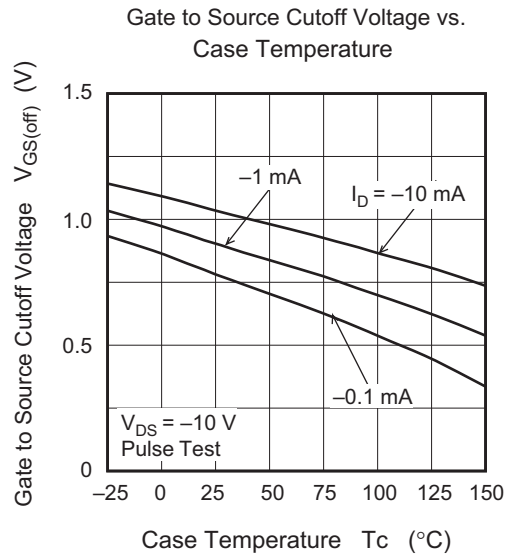
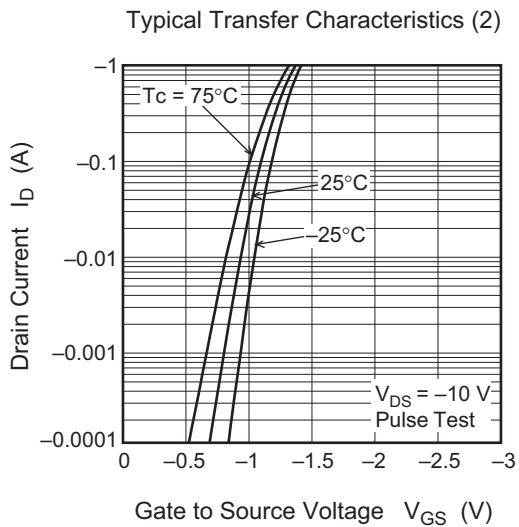
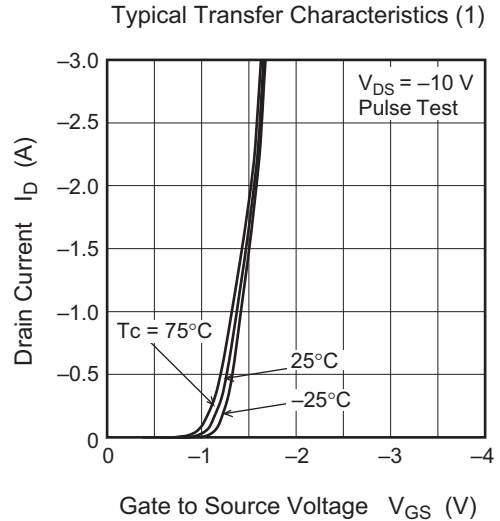
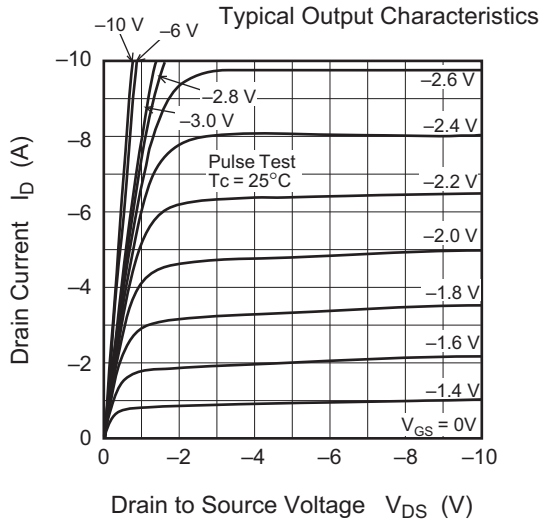
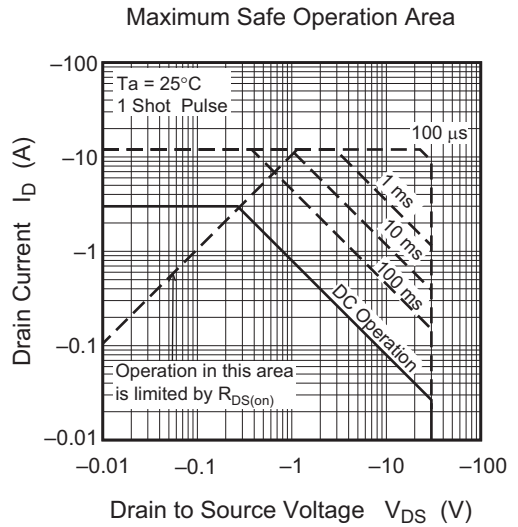
| Item                                | Symbol        | Min  | Typ  | Max  | Unit             | Test conditions   |
|-------------------------------------|---------------|------|------|------|------------------|---|
| Drain to source breakdown voltage   | $V_{(BR)DSS}$ | -30  | —    | —    | V                | $I_D = -10 \text{ mA}$ , $V_{GS} = 0$   |
| Gate to source breakdown voltage    | $V_{(BR)GSS}$ | +8   | —    | —    | V                | $I_G = +100 \text{ }\mu\text{A}$ , $V_{DS} = 0$   |
| Gate to source breakdown voltage    | $V_{(BR)GSS}$ | -12  | —    | —    | V                | $I_G = -100 \text{ }\mu\text{A}$ , $V_{DS} = 0$   |
| Gate to source leak current         | $I_{GSS}$     | —    | —    | +10  | $\mu\text{A}$    | $V_{GS} = +6 \text{ V}$ , $V_{DS} = 0$  |
| Gate to source leak current         | $I_{GSS}$     | —    | —    | -10  | $\mu\text{A}$    | $V_{GS} = -10 \text{ V}$ , $V_{DS} = 0$   |
| Drain to source leak current        | $I_{DSS}$     | —    | —    | -1   | $\mu\text{A}$    | $V_{DS} = -30 \text{ V}$ , $V_{GS} = 0$   |
| Gate to source cutoff voltage       | $V_{GS(off)}$ | -0.4 | —    | -1.4 | V                | $V_{DS} = -10 \text{ V}$ , $I_D = -1 \text{ mA}$  |
| Drain to source on state resistance | $R_{DS(on)}$  | —    | 75   | 95   | $\text{m}\Omega$ | $I_D = -1.5 \text{ A}$ , $V_{GS} = -4.5 \text{ V}$ <sup>Note3</sup>   |
| Drain to source on state resistance | $R_{DS(on)}$  | —    | 120  | 165  | $\text{m}\Omega$ | $I_D = -1.5 \text{ A}$ , $V_{GS} = -2.5 \text{ V}$ <sup>Note3</sup>   |
| Forward transfer admittance         | $ y_{fs} $    | 3.5  | 5.2  | —    | S                | $I_D = -1.5 \text{ A}$ , $V_{DS} = -10 \text{ V}$ <sup>Note3</sup>  |
| Input capacitance                   | $C_{iss}$     | —    | 510  | —    | pF               | $V_{DS} = -10 \text{ V}$ , $V_{GS} = 0$ ,<br>$f = 1 \text{ MHz}$  |
| Output capacitance                  | $C_{oss}$     | —    | 100  | —    | pF               |   |
| Reverse transfer capacitance        | $C_{rss}$     | —    | 58   | —    | pF               |   |
| Turn - on delay time                | $t_{d(on)}$   | —    | 18   | —    | ns               | $I_D = -1.5 \text{ A}$<br>$V_{GS} = -4.5 \text{ V}$<br>$R_L = 6.7 \text{ }\Omega$<br>$R_g = 4.7 \text{ }\Omega$ |
| Rise time                           | $t_r$         | —    | 48   | —    | ns               |   |
| Turn - off delay time               | $t_{d(off)}$  | —    | 47   | —    | ns               |   |
| Fall time                           | $t_f$         | —    | 13   | —    | ns               |   |
| Total gate charge                   | $Q_g$         | —    | 4.8  | —    | nC               | $V_{DD} = -10 \text{ V}$  |
| Gate to Source charge               | $Q_{gs}$      | —    | 0.8  | —    | nC               | $V_{GS} = -4.5 \text{ V}$   |
| Gate to drain charge                | $Q_{gd}$      | —    | 1.8  | —    | nC               | $I_D = -3.0 \text{ A}$  |
| Body - drain diode forward voltage  | $V_{DF}$      | —    | -0.8 | -1.2 | V                | $I_F = -3.0 \text{ A}$ , $V_{GS} = 0$ <sup>Note3</sup>  |

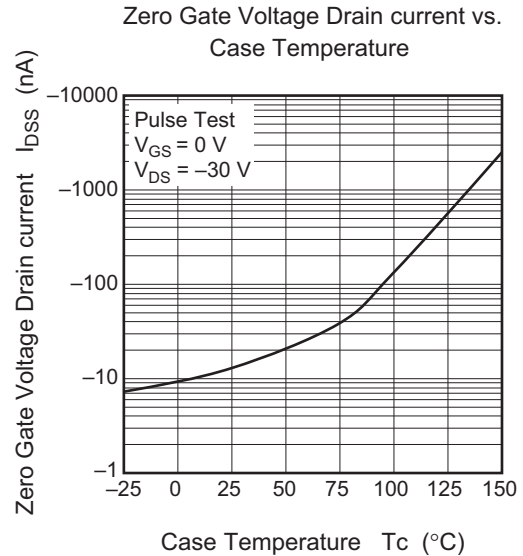
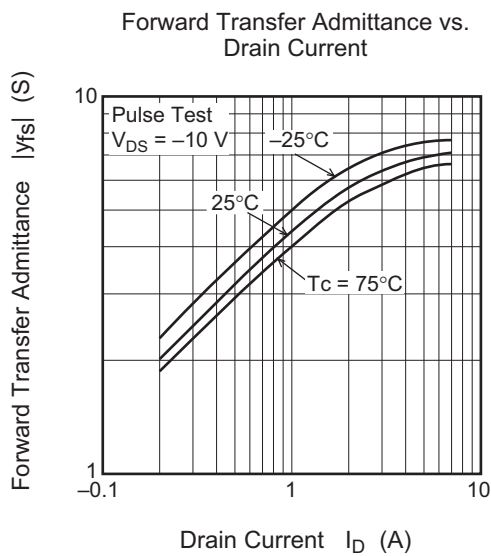
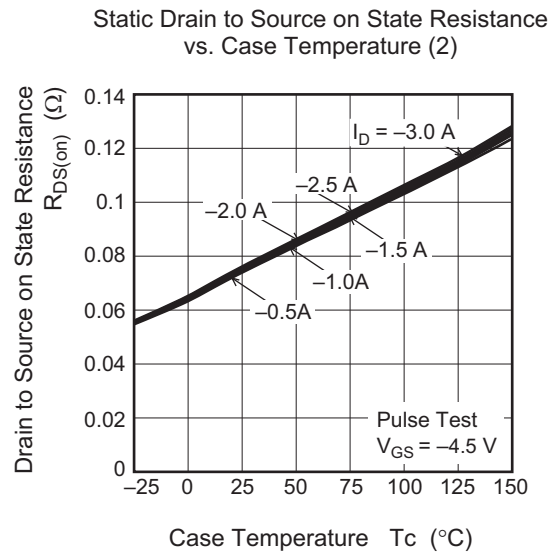
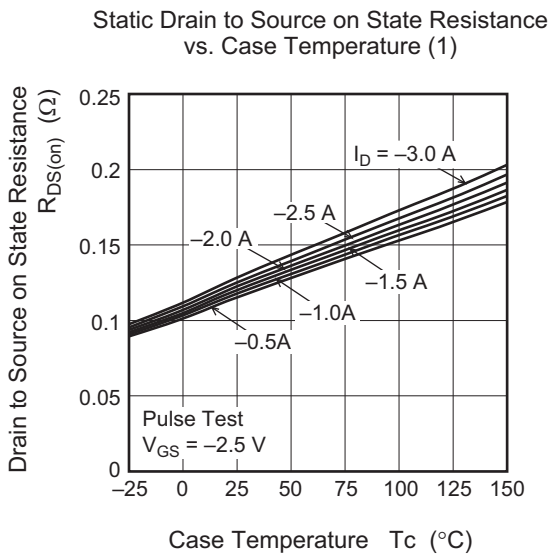
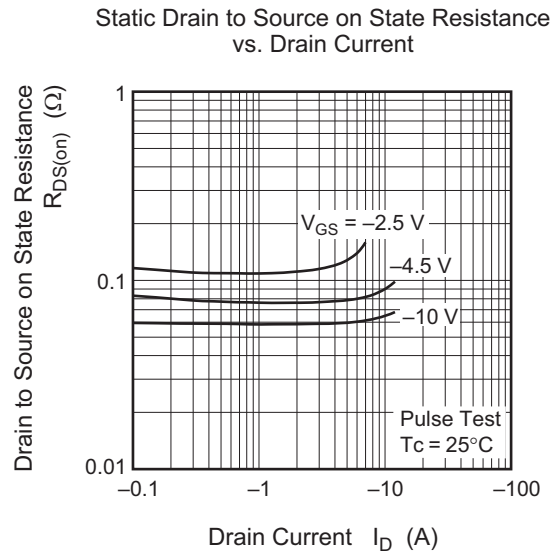
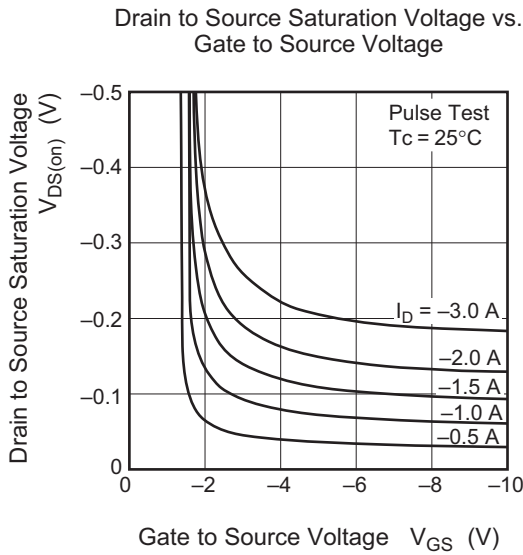
Notes: 3. Pulse test

Main Characteristics

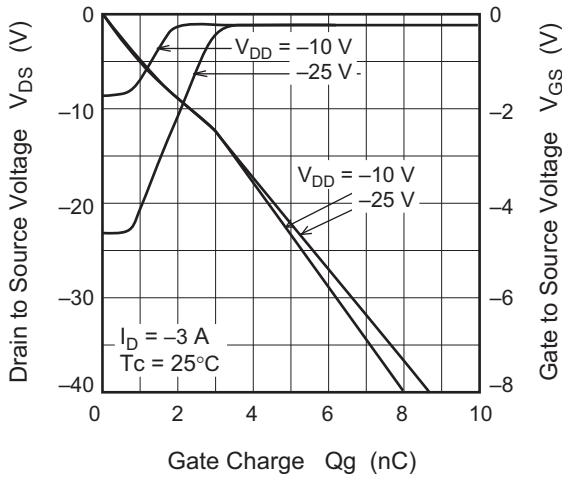


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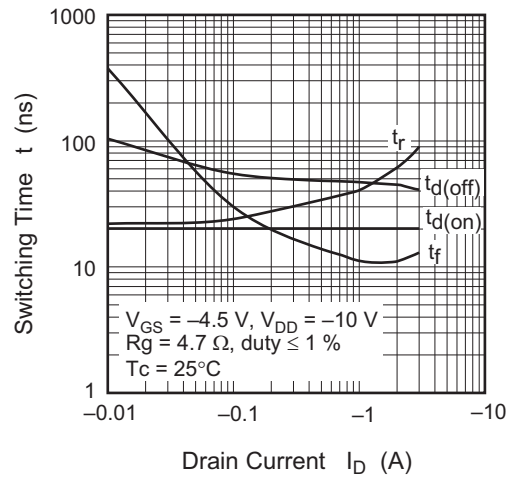




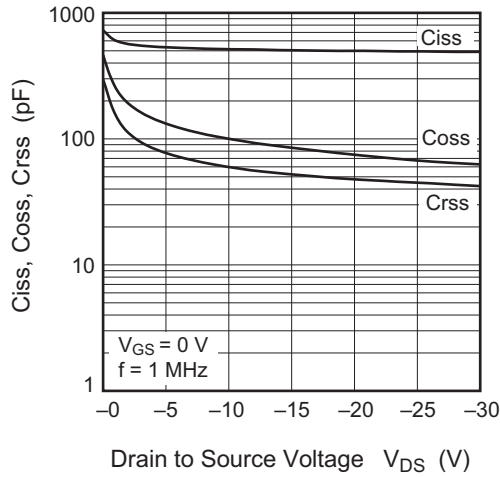
Dynamic Input Characteristics



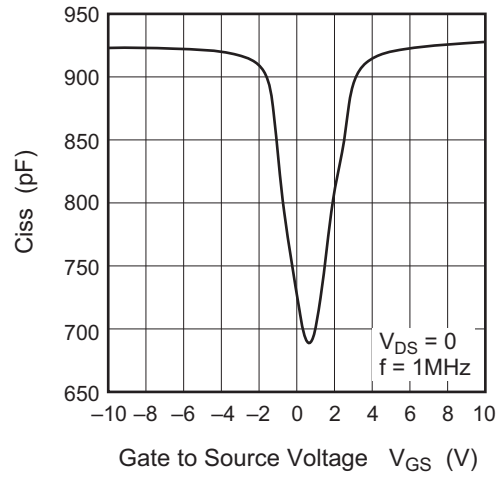
Switching Characteristics



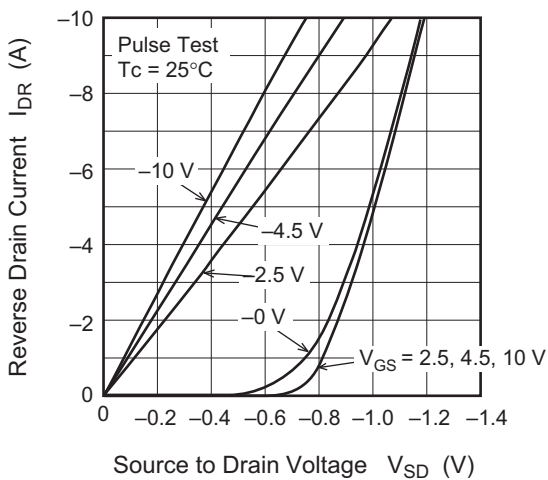
Typical Capacitance vs. Drain to Source Voltage



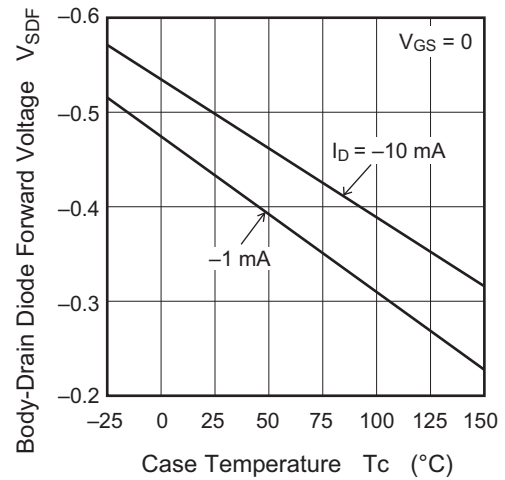
Input Capacitance vs. Gate to Source Voltage

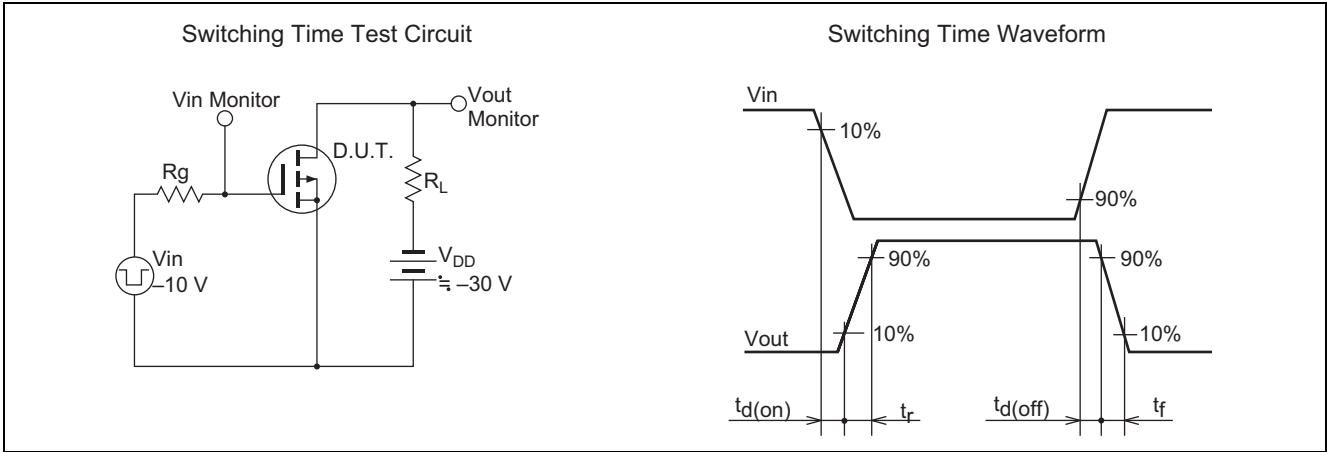


Reverse Drain Current vs. Source to Drain Voltage



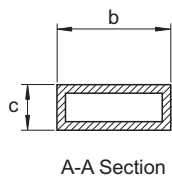
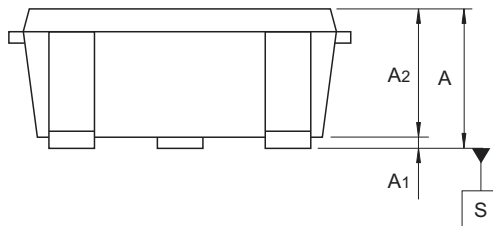
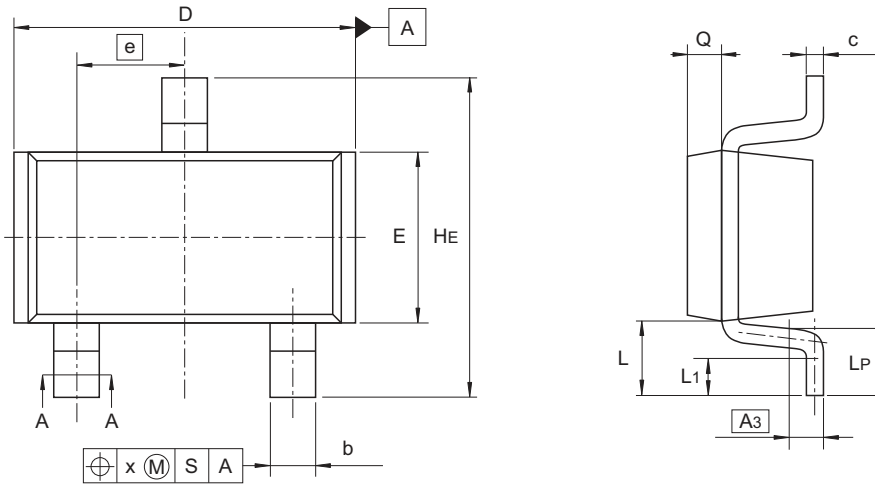
Body-Drain Diode Forward Voltage vs. Case Temperature





### Package Dimensions

| JEITA Package Code | RENESAS Code | Previous Code      | MASS (Typ) [g] |
|--------------------|--------------|--------------------|----------------|
| SC-59A             | PLSP0003ZB-A | MPAK(T) / MPAK(T)V | 0.011          |



| Reference Symbol | Dimensions in millimeters |      |      |
|------------------|---------------------------|------|------|
|                  | Min                       | Nom  | Max  |
| A                | 1.0                       | —    | 1.3  |
| A1               | 0                         | —    | 0.1  |
| A2               | 1.0                       | 1.1  | 1.2  |
| A3               | —                         | 0.25 | —    |
| b                | 0.35                      | 0.4  | 0.5  |
| c                | 0.1                       | 0.16 | 0.26 |
| D                | 2.7                       | —    | 3.1  |
| E                | 1.35                      | 1.5  | 1.65 |
| e                | —                         | 0.95 | —    |
| HE               | 2.2                       | 2.8  | 3.0  |
| L                | 0.35                      | —    | 0.75 |
| L1               | 0.15                      | —    | 0.55 |
| LP               | 0.25                      | —    | 0.65 |
| x                | —                         | —    | 0.05 |
| Q                | —                         | 0.3  | —    |

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### Ordering Information

| Orderable Part Number | Quantity  | Shipping Container               |
|-----------------------|-----------|----------------------------------|
| RQJ0306FQDQATL-H      | 3000 pcs. | φ178 mm reel, 8 mm Emboss taping |



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